

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION**
(Joint Inventors)

We as the below named inventors, declare that:

Our residences, post office addresses and citizenships are as stated below next to our names.

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which patent is sought on the invention entitled:

**TEST INTERCONNECT FOR BUMP'ED SEMICONDUCTOR
COMPONENTS AND METHOD OF FABRICATION**

the specification of which (check one)

is attached hereto.

was filed on _____ as Application
Serial No. _____
and was amended on (if applicable) _____.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Sec. 1.56(a).

We hereby claim foreign priority under Title 35, United States Code, Sec. 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: NONE

We hereby claim the benefit under Title 35, United States Code, Sec. 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 11, we acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Sec. 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application: NONE

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POWER OF ATTORNEY: We hereby appoint as our attorneys, STEPHEN A. GRATTON, Registration No. 28,418; MICHAEL L. LYNCH, Registration No. 30,871; and LIA M. DENNISON, Registration No. 34,095, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. All correspondence and telephonic communications should be directed to:

STEPHEN A. GRATTON
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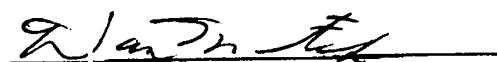
We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Wherefore, we pray that Letters Patent be granted to us for the invention or discovery described and claimed in the foregoing specification and claims, declaration, power of attorney, and this petition.

INVENTOR'S FULL NAME:

WARREN M FARNWORTH

INVENTOR'S SIGNATURE:



DATE OF SIGNATURE:

3 - 8 - 99

RESIDENCE (CITY AND STATE):

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INVENTOR'S FULL NAME: **SALMAN AKRAM**

INVENTOR'S SIGNATURE: *Salman Akram*

DATE OF SIGNATURE: *3/8/1999*

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MICRON TECHNOLOGY, INC.